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August 2001



### FDC3601N Dual N-Channel 100V Specified PowerTrench®MOSFET

#### **General Description**

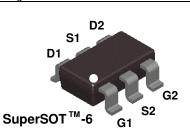
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These N-Channel 100V specified MOSFETs are produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize on-state resistance and yet maintain low gate charge for superior switching performance.

These devices have been designed to offer exceptional power dissipation in a very small footprint for applications where the bigger more expensive SO-8 and TSSOP-8 packages are impractical.

#### Applications

- Load switch
- Battery protection
- Power management



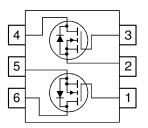
#### Features

• 1.0 A, 100 V.  $R_{DS(ON)}$ = 500 m $\Omega$  @ V<sub>GS</sub> = 10 V

 $R_{DS(ON)}$ = 550 m $\Omega$  @ V<sub>GS</sub> = 6.0 V

- Low gate charge (3.7nC typical)
- Fast switching speed.
- High performance trench technology for extremely low R  $_{\text{DS}(\text{ON})}$  .
- SuperSOT<sup>™</sup>-6 package: small footprint 72%

(smaller than standard SO-8); low profile (1mm thick).



#### Absolute Maximum Ratings T<sub>A=25°C unless otherwise noted</sub>

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage		100	V
V <sub>GSS</sub>	Gate-Source Voltage		±20	V
ID	Drain Current – Continuous	(Note 1a)	1.0	А
	– Pulsed		4.0	
P <sub>D</sub>	Power Dissipation for Single Operation	(Note 1a)	0.96	W
		(Note 1b)	0.9	
		(Note 1c)	0.7	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to +150	°C
Therma	I Characteristics			
R <sub>0JA</sub>	Thermal Resistance, Junction-to-Ambient	(Note 1a)	130	°C/W
R <sub>eJC</sub>	Thermal Resistance, Junction-to-Case	(Note 1)	60	°C/W

Device Marking Device	Reel Size	Tape width	Quantity				
.601 FDC3601N	7"	8mm	3000 units				

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FDC3601N

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$ , $I_D = 250 \mu A$	100			V
$\Delta BV_{DSS} \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A,Referenced to 25°C		105		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 80 V$ , $V_{GS} = 0 V$			10	μA
I <sub>GSSF</sub>	Gate-Body Leakage, Forward	$V_{GS} = 20 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			100	nA
I <sub>GSSR</sub>	Gate-Body Leakage, Reverse	$V_{GS} = -20 V$ , $V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)				•	
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	2	2.6	4	V
<u>ΔVGS(th)</u> ΔT <sub>J</sub>	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A,Referenced to $25^{\circ}$ C		-5		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance	$ \begin{array}{c c} V_{GS} = 10 \ V, & I_D = 1.0 \ A \\ V_{GS} = 6 \ V, & I_D = 0.9 \ A \\ V_{GS} = 10 \ V, I_D = 1.0 \ A, \ T_J = 125^\circ C \end{array} $		370 396 685	500 550 976	mΩ
I <sub>D(on)</sub>	On-State Drain Current	$V_{GS} = 10 \text{ V}, \qquad V_{DS} = 10 \text{ V}$	3			Α
<b>g</b> fs	Forward Transconductance	$V_{DS} = 5V,$ $I_{D} = 1.0 \text{ A}$		3.6		S
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 50 V$ , $V_{GS} = 0 V$ ,		153		pF
Coss	Output Capacitance	f = 1.0 MHz		5		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			1		pF
Switchir	g Characteristics (Note 2)					
t <sub>d(on)</sub>	Turn–On Delay Time	$\label{eq:V_DD} \begin{array}{l} V_{\text{DD}} = 50 \ \text{V}, & I_{\text{D}} = 1 \ \text{A}, \\ V_{\text{GS}} = 10 \ \text{V}, & R_{\text{GEN}} = 6 \ \Omega \end{array}$		8	16	ns
tr	Turn–On Rise Time			4	8	ns
t <sub>d(off)</sub>	Turn–Off Delay Time			11	20	ns
t <sub>f</sub>	Turn–Off Fall Time			6	12	ns
Qg	Total Gate Charge	$V_{DS} = 50 \text{ V}, \qquad I_{D} = 1.0 \text{ A},$		3.7	5	nC
Q <sub>gs</sub>	Gate-Source Charge	$V_{GS} = 10 V$		0.8		nC
Q <sub>gd</sub>	Gate-Drain Charge	_		1		nC
Drain-S	ource Diode Characteristics	and Maximum Ratings				
I <sub>S</sub>	Maximum Continuous Drain-Source	0			0.8	Α
V <sub>SD</sub>	Drain–Source Diode Forward Voltage	$V_{GS} = 0 \ V,  I_S = 0.8 \ A \qquad (Note 2)$		0.8	1.2	V

the drain pins.  $R_{BJC}$  is guaranteed by design while  $R_{BCA}$  is determined by the user's board design.



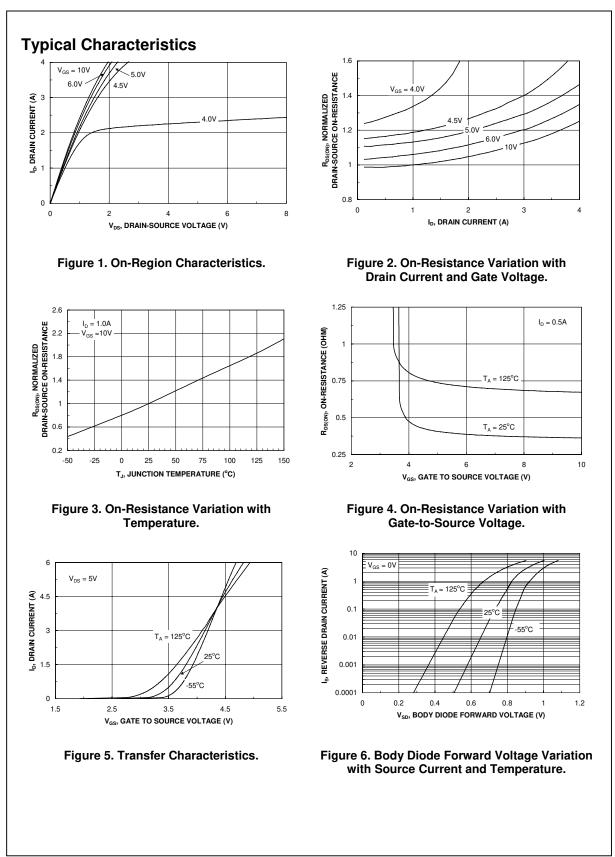
130 °C/W when mounted on a 0.125 in<sup>2</sup> pad of 2 oz. copper.

b) 140°C/W when mounted on a .004 in<sup>2</sup> pad of 2 oz copper

c) 180°C/W when mounted on a minimum pad.

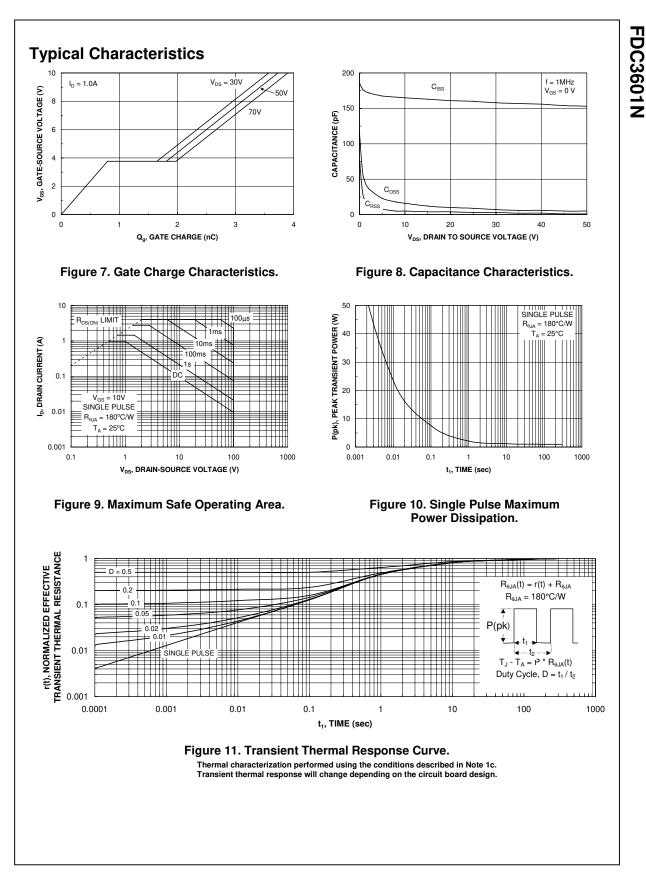
2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%

a)



FDC3601N Rev C(W)

# FDC3601N



FDC3601N Rev C(W)

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